

ICS 31.030

JB

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

JB/T 6173-2014

Replacing JB/T 6173-1992

No-clean lead-free soldering fluxes

免清洗无铅助焊剂

(English Translation)

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2 Normative references

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JB/T 6173-2014 cites the following standards, which apply in full or in part through the references made to them in its clauses.

GB 190-2009

GB/T 191-2008

GB/T 611-2006

GB/T 2040-2008

GB/T 2423.32-2008

GB/T 2828.1-2012

GB/T 2829-2002

GB/T 9724-2007

SH 0164-1992

YB/T 724-2005